



OKI Semiconductor

FEDR27V6454G-02-05 Issue Date: Jul. 9, 2004

MR27V6454G

4M-Word × 16-Bit Page Mode P2ROM

FEATURES

- \cdot 4,194,304-word \times 16-bit configuration
- · Page size of 8-word x 16-Bit
- · 3.0 V to 3.6 V power supply

Random Access timePage Access time30 ns MAX

· Operating current 50 mA MAX (5MHz)

· Standby current 10 µA MAX

· Input/Output TTL compatible

· Three-state output

PACKAGES

·MR27V6454G-xxxTN 48-pin plastic TSOP (TSOP I 48-P-1220-0.50-1K)

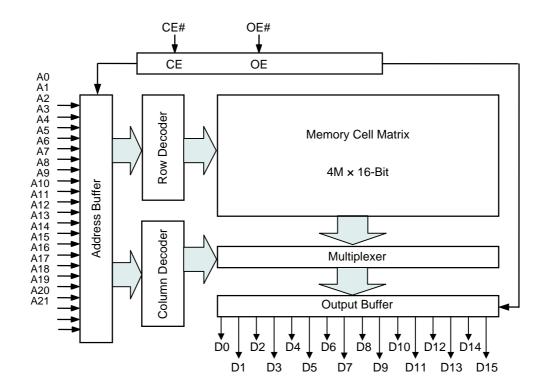
P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- Custom Marking is available at no additional charge.
- Pin Compatible with Mask ROM and some FLASH products.

PIN CONFIGURATION (TOP VIEW) 48 A16 A15 1 47 V_{CC} A13 46 V_{SS} 45 D15 A12 44 D7 A11 5 A10 43 D14 42 D6 A9 41 D13 Α8 40 D5 A21 39 D12 A20 10 NC 38 D4 NC 37 V_{CC} 36 D11 NC 35 D3 14 NC 34 D10 A19 15 A18 33 D2 32 D9 A17 31 D1 A7 18 30 D8 19 A6 A5 20 29 D0 A4 28 OE# A3 22 27 V_{SS} 26 CE# A2 23 A1 24 25 A0 48TSOP(Type-I)

BLOCK DIAGRAM



PIN DESCRIPTIONS

Pin name	Functions			
A0 to A21	Address inputs			
D0 to D15	Data outputs			
CE#	Chip enable input			
OE#	Output enable input			
V _{CC}	Power supply voltage			
V_{SS}	Ground			
NC	No connect			

FUNCTION TABLE

Mode	CE#	OE#	V _{CC}	D0 to D15
Read	L	L		Dout
Output disable	L	Н	3.3 V	Hi–Z
Standby	Н	*		Hi–Z

^{*:} Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	V_{I}		-0.5 to V _{CC} +0.5	V
Output voltage	Vo	relative to V _{SS}	-0.5 to V _{CC} +0.5	V
Power supply voltage	V _{CC}		–0.5 to 5	V
Power dissipation per package	P_D	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	V _{CC}		3.0	_	3.6	V
Input "H" level	V _{IH}	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	2.2	_	V _{CC} +0.5*	V
Input "L" level	V_{IL}		-0.5**	_	0.6	V

Voltage is relative to V_{SS} .

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

PIN CAPACITANCE

 $(V_{CC} = 3.3 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}, \text{ f} = 1 \text{ MHz})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	$V_I = 0 V$	_	_	8	pF
Output	C _{OUT}	$V_O = 0 V$	_	_	10	

^{**: -1.5}V(Min.) when pulse width of undershoot is less than 10ns.

ELECTRICAL CHARACTERISTICS

DC Characteristics

 $(V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}	_	_	10	μΑ
Output leakage current	I _{LO}	$V_O = 0$ to V_{CC}	_	_	10	μА
V _{CC} power supply current	Iccsc	CE# = V _{CC}	_	_	10	μΑ
(Standby)	I _{CCST}	CE# = V _{IH}	_	_	1	mA
V _{CC} power supply current	I _{CCA}	$CE\# = V_{IL}, OE\# = V_{IH}$	_	_	50	mA
(Read)		f=5MHz				
Input "H" level	V_{IH}		2.2	_	V _{CC} +0.5*	V
Input "L" level	V _{IL}	_	-0.5**	_	0.6	V
Output "H" level	V _{OH}	$I_{OH} = -2 \text{ mA}$	2.4	_	_	V
Output "L" level	V _{OL}	$I_{OL} = 4 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS} .

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC Characteristics

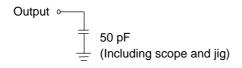
 $(V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	tc	_	100	_	ns
Address access time	t _{ACC}	CE# = OE# = V _{IL}	_	100	ns
Page cycle time	t _{PC}	_	30	_	ns
Page access time	t _{PAC}	_	_	30	ns
CE# access time	t _{CE}	OE# = V _{IL}	_	100	ns
OE# access time	t _{OE}	CE# = V _{IL}	_	25	ns
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0	_	ns

Measurement conditions

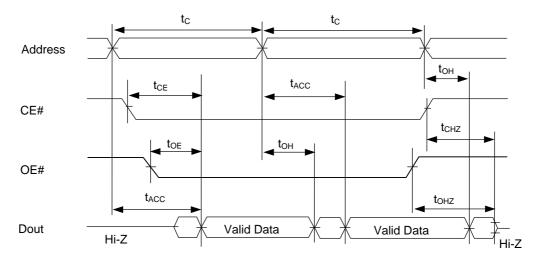
Input signal level ------0 V/3.0 V Input timing reference level-------1/2Vcc Output load ------50 pF Output timing reference level ------1/2Vcc

Output load

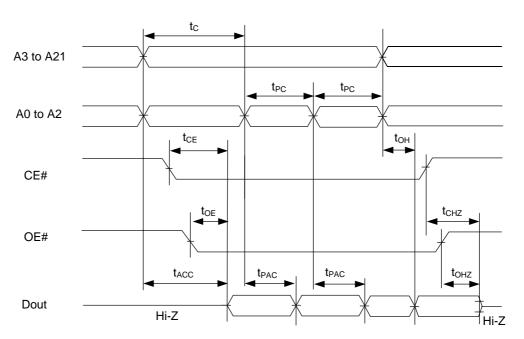


TIMING CHART (READ CYCLE)

RANDOM ACCESS MODE READ CYCLE

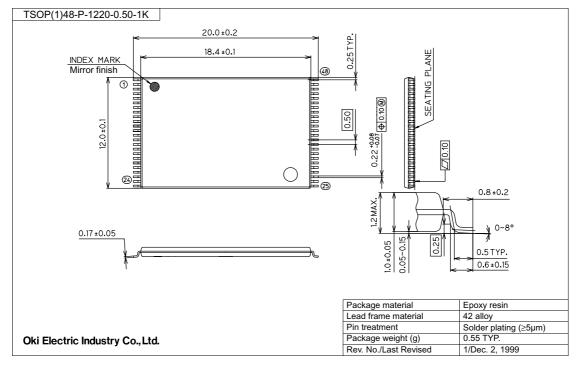


PAGE ACCESS MODE READ CYCLE



PACKAGE DIMENSIONS





Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document		Page		
No.	Date	Previous Current Edition Edition		Description
FEDR27V6454G-02-01	Apr., 2003	ı	ı	Final edition 1
FEDR27V6454G-02-02	May., 2003	1	1	Change 48TSOP(1) package code to -1K
FEDR27V6454G-02-03	Jun. 4, 2003	1,4	1,4	Change t _{ACC} , t _{PAC} to 100ns,30ns
FEDR27V6454G-02-04	Jul. 16, 2003	4	4	Change t _{CHZ} to 20ns
FEDR27V6454G-02-05	Jul. 9, 2004	3	3	Add P _D condition and I _{OS} = 10mA

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